

CD40147B Types

10-Line to 4-Line BCD Priority Encoder

High-Voltage Types (20-Volt Rating)

The CD40147B CMOS encoder features priority encoding of the inputs to ensure that only the highest-order data line is encoded. Ten data input lines (0-9) are encoded to four-line (8, 4, 2, 1) BCD. The highest priority line is line 9. All four output lines are logic 1 (V_{SS}) when all input lines are logic 0. All inputs and outputs are buffered, and each output can drive one TTL low-power Schottky load. The CD40147B is functionally similar to the TTL54/74147 if pin 15 is tied low.

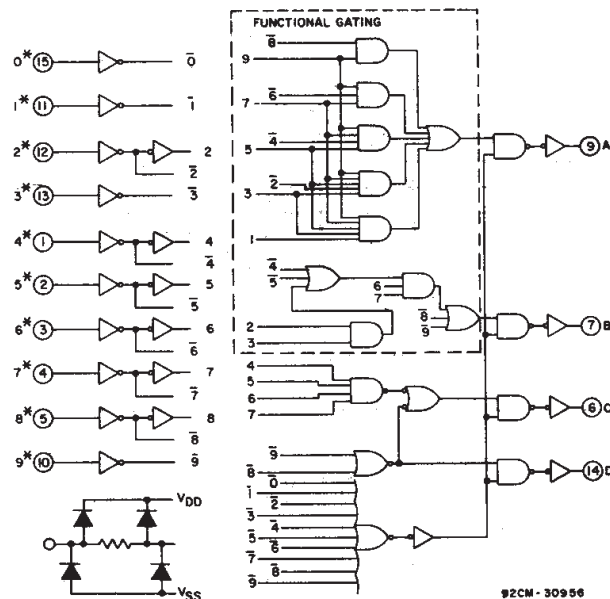
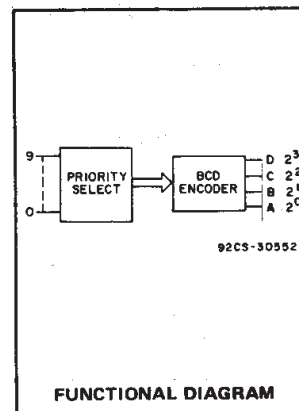
The CD40147B types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- Encodes 10-line to 4-line BCD
- Active low inputs and outputs
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13A, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Maximum input current of 1 μ A at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) =
 - 1 V at $V_{DD} = 5$ V
 - 2 V at $V_{DD} = 10$ V
 - 2.5 V at $V_{DD} = 15$ V

Applications:

- Keyboard encoding
- 10-line to BCD encoding
- Range selection



* INPUTS PROTECTED BY
COS/MOS PROTECTION NETWORK

Fig. 1 - CD40147B logic diagram.

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following range:

CHARACTERISTIC	LIMITS		UNITS
	Min.	Max.	
Supply Voltage Range (For T_A = Full Package Temperature Range)	3	18	V

TRUTH TABLE (Negative Logic)

INPUTS										OUTPUTS			
0	1	2	3	4	5	6	7	8	9	D	C	B	A
0	0	0	0	0	0	0	0	0	0	1	1	1	1
1	0	0	0	0	0	0	0	0	0	0	0	0	0
X	1	0	0	0	0	0	0	0	0	0	0	0	1
X	X	1	0	0	0	0	0	0	0	0	0	1	0
X	X	X	1	0	0	0	0	0	0	0	0	1	1
X	X	X	X	1	0	0	0	0	0	0	1	0	0
X	X	X	X	X	1	0	0	0	0	0	1	1	0
X	X	X	X	X	X	1	0	0	0	0	1	1	1
X	X	X	X	X	X	X	1	0	0	0	1	0	0
X	X	X	X	X	X	X	X	1	0	1	0	0	0
X	X	X	X	X	X	X	X	X	1	1	0	0	1

0 = High Level

1 = Low Level

X = Don't Care

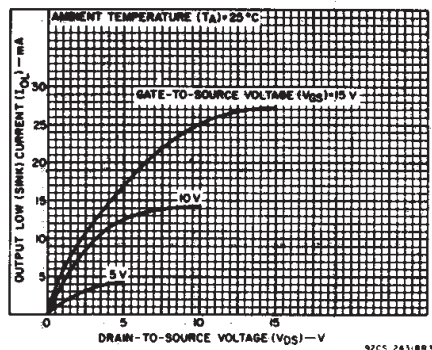


Fig. 2 - Typical output low (sink) current characteristics.

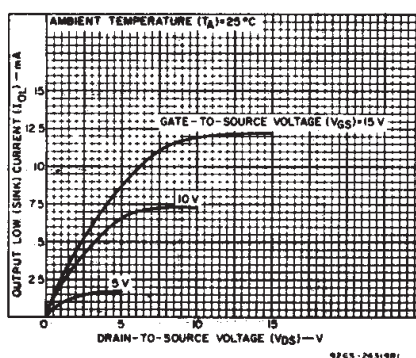


Fig. 3 - Minimum output low (sink) current characteristics.

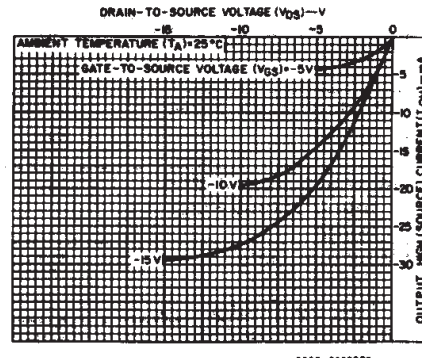


Fig. 4 - Typical output high (source) current characteristics.

CD40147B Types

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal) -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to $V_{DD} + 0.5V$

DC INPUT CURRENT, ANY ONE INPUT $\pm 10\text{mA}$

POWER DISSIPATION PER PACKAGE (P_D):

For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ 500mW

For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ Derate Linearly at $12\text{mW}/^\circ\text{C}$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$ 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to $+150^\circ\text{C}$

LEAD TEMPERATURE (DURING SOLDERING):

At distance $1/16 \pm 1/32$ inch ($1.59 \pm 0.79\text{mm}$) from case for 10s max $+265^\circ\text{C}$

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent	—	0,5	5	5	5	150	150	—	0.04	5	μA
Device	—	0,10	10	10	10	300	300	—	0.04	10	
Current, I _{DD}	—	0,15	15	20	20	600	600	—	0.04	20	
Max.	—	0,20	20	100	100	3000	3000	—	0.08	100	
Output Low (Sink)	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	—	mA
Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	—	
I _{OL} Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	—	
Output (Source)	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	—	mA
	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	—	
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	—	
I _{OH} Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	—	
Output Voltage:	—	0,5	5	0.05				—	0	0.05	V
Low-Level,	—	0,10	10	0.05				—	0	0.05	
V _{OL} Max.	—	0,15	15	0.05				—	0	0.05	
Output Voltage:	—	0,5	5	4.95				4.95	5	—	V
High-Level,	—	0,10	10	9.95				9.95	10	—	
V _{OH} Min.	—	0,15	15	14.95				14.95	15	—	
Input Low	0.5,4.5	—	5	1.5				—	—	1.5	V
Voltage,	1,9	—	10	3				—	—	3	
V _{IL} Max.	1.5,13.5	—	15	4				—	—	4	
Input High	0.5,4.5	—	5	3.5				3.5	—	—	V
Voltage,	1,9	—	10	7				7	—	—	
V _{IH} Min.	1.5,13.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA

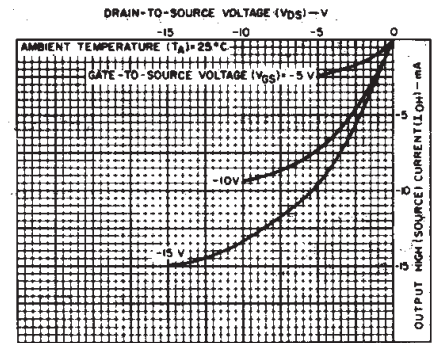


Fig. 5 — Minimum output high (source) current characteristics.

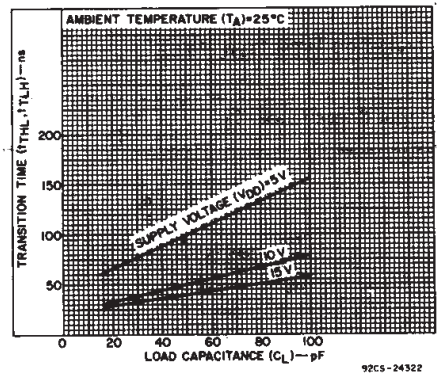


Fig. 6 — Typical transition time as a function of load capacitance.

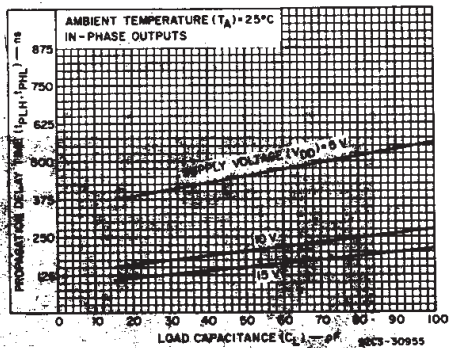


Fig. 7 — Propagation delay time as a function of load capacitance.

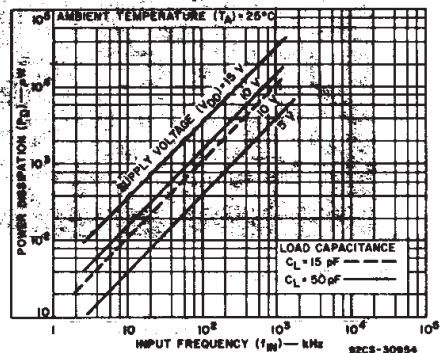


Fig. 8 — Typical dynamic power dissipation as a function of input frequency.

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DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$, Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS ALL TYPES			UNITS
		V _{DD} (V)	Typ.	Max.	
Propagation Delay Time, t _{PLH} , t _{PHL} In-Phase Output	Any input to any output	5	450	900	ns
Out-of-Phase Output		10	200	400	
		15	150	300	
		5	425	850	ns
10		175	350		
15		125	250		
Transition Time, t _{THL} , t _{TLH}		5	100	200	ns
		10	50	100	
		15	40	80	
Input Capacitance, C ₁	Any Input		5	7.5	pF

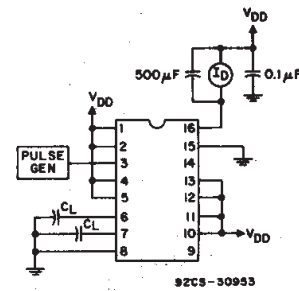


Fig. 9 - Dynamic power dissipation test circuit.

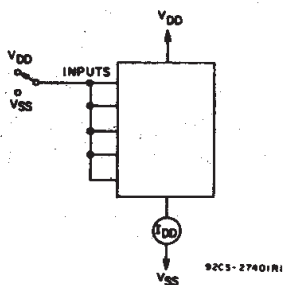


Fig. 10 - Quiescent device current test circuit.

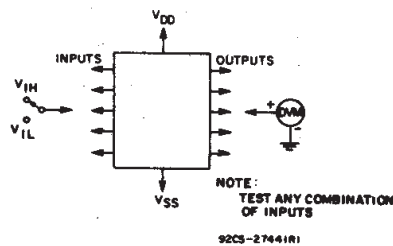


Fig. 11 - Input voltage test circuit.

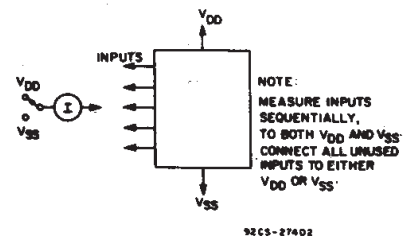
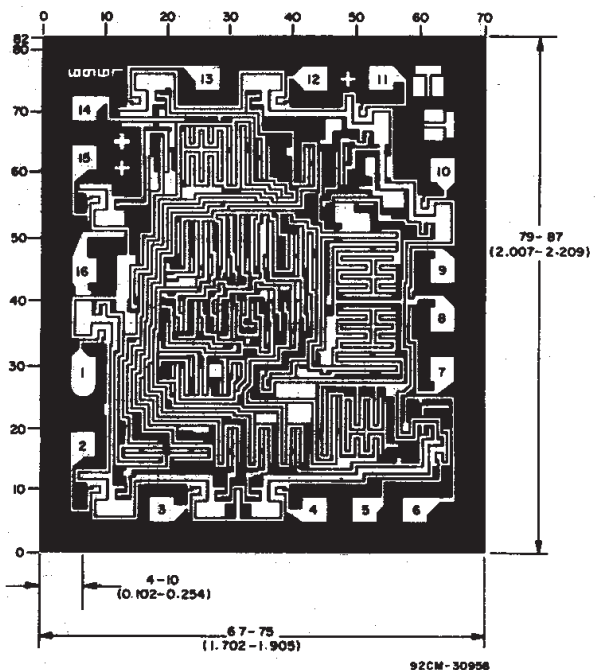
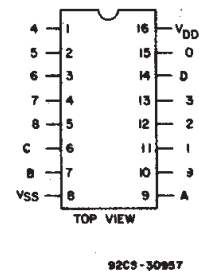


Fig. 12 - Input current test circuit.



Dimensions and pad layout for CD40147BH



CD40147B
TERMINAL
ASSIGNMENT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
CD40147BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40147BE
CD40147BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40147BE
CD40147BEE4	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD40147BE
CD40147BM	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD40147BM
CD40147BM.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD40147BM

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE

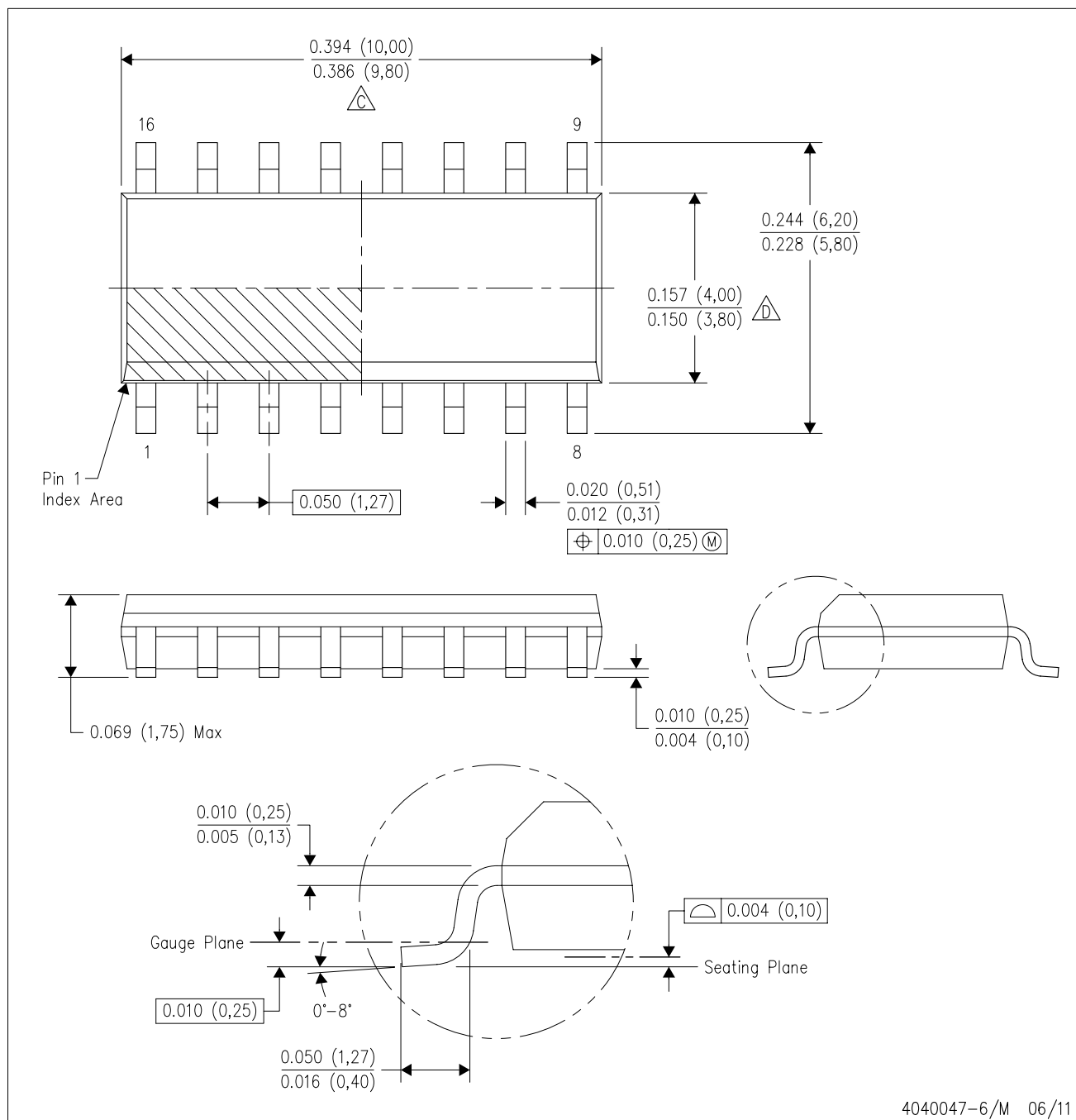


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
CD40147BE	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BE	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BEE4	N	PDIP	16	25	506	13.97	11230	4.32
CD40147BM	D	SOIC	16	40	507	8	3940	4.32
CD40147BM.A	D	SOIC	16	40	507	8	3940	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

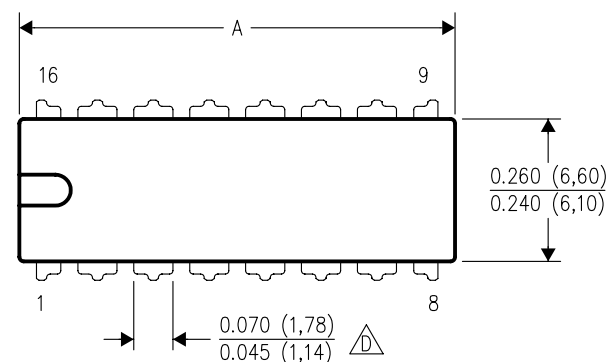


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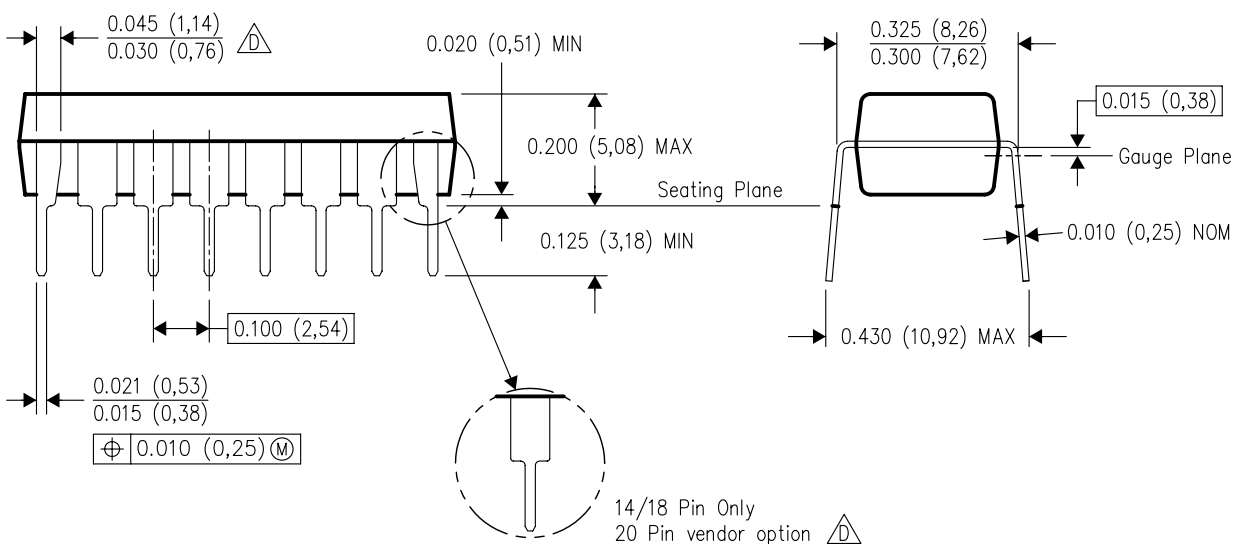
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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